TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type

# SSM3J108TU

#### High Speed Switching Applications

- 1.8V drive
- Low on-resistance:  $R_{on} = 363m\Omega (max) (@V_{GS} = -1.8 V)$

 $R_{on}$  = 230m $\Omega$  (max) (@V\_{GS} = -2.5 V)

 $R_{on} = 158m\Omega \text{ (max)} (@V_{GS} = -4.0 \text{ V})$ 

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-Source voltage		V <sub>DS</sub>	-20	V	
Gate-Source voltage		V <sub>GSS</sub>	± 8	V	
Drain current	DC	۱ <sub>D</sub>	-1.8	А	
	Pulse	I <sub>DP</sub>	-3.6	~	
Drain power dissipation		PD (Note 1)	800	mW	
	n power dissipation		500		
Channel temperature		P <sub>D (Note 2)</sub> T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

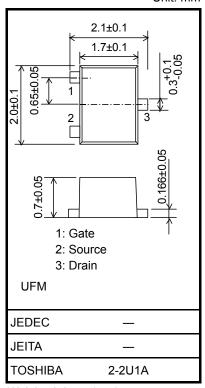
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling

Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on ceramic board. (25.4 mm  $\times$  25.4 mm  $\times$  0.8 mm, Cu Pad: 645 mm<sup>2</sup>) Note 2: Mounted on FR4 board.

(25.4 mm imes 25.4 mm imes 1.6 mm, Cu Pad: 645 mm $^2$  )

#### **Electrical Characteristics (Ta = 25°C)**



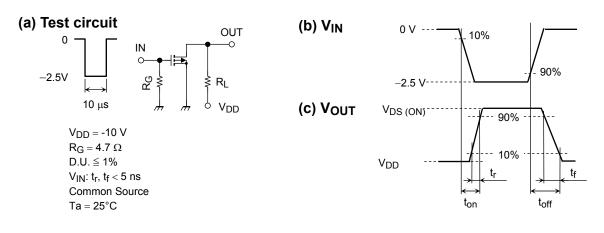
Weight: 6.6 mg (typ.)

Characte	eristic	Symbol	Test Conditions		Min	Тур.	Max	Unit
Drain-Source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$ $I_D = -1 \text{ mA}, V_{GS} = +8 \text{ V}$		-20	_		V
		V (BR) DSX			-12		—	
Drain cut-off curren	t	I <sub>DSS</sub>	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0$		—	—	-10	μA
Gate leakage curre	nt	I <sub>GSS</sub>	$V_{GS}=\pm 8V, \ V_{DS}=0$		_	_	±1	μA
Gate threshold volta	age	V <sub>th</sub>	$V_{DS} = -3 V, I_D = -1 mA$		-0.3	_	-1.0	V
Forward transfer ad	Imittance	Y <sub>fs</sub>	$V_{DS} = -3 V, I_D = -0.8 A$	(Note3)	1.9	3.2		S
Drain-Source on-resistance		R <sub>DS (ON)</sub>	$I_D = -0.8 \text{ A}, V_{GS} = -4.0 \text{ V}$	(Note3)		125	158	mΩ
			$I_D = -0.4 \text{ A}, V_{GS} = -2.5 \text{ V}$	(Note3)		170	230	
			$I_D = -0.1 \text{ A}, V_{GS} = -1.8 \text{ V}$	(Note3)		230	363	
Input capacitance		C <sub>iss</sub>	$V_{DS}=-10~V,~V_{GS}=0,~f=1~MHz$		—	250	—	pF
Output capacitance	!	C <sub>oss</sub>	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0, \text{ f} = 1 \text{ MHz}$		_	45		pF
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0, \text{ f} = 1 \text{ MHz}$		_	35		pF
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = -10 \text{ V}, \text{ I}_D = -0.25 \text{ A},$ $V_{GS} = 0$ ~-2.5 V, $R_G = 4.7 \Omega$			12		ns
	Turn-off time	t <sub>off</sub>				18	_	
Drain-Source forward voltage		V <sub>DSF</sub>	I <sub>D</sub> = 1.8A, V <sub>GS</sub> = 0 V	(Note3)	_	0.85	1.2	V

Unit: mm

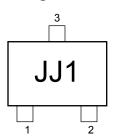
# <u>TOSHIBA</u>

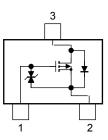
### Switching Time Test Circuit



#### Marking

#### Equivalent Circuit (top view)





#### Precaution

 $V_{th}$  can be expressed as the voltage between gate and source when the low operating current value is I<sub>D</sub>=-1mA for this product. For normal switching operation,  $V_{GS}$  (on) requires a higher voltage than  $V_{th}$ , and  $V_{GS}$  (off) requires a lower voltage than  $V_{th}$ .

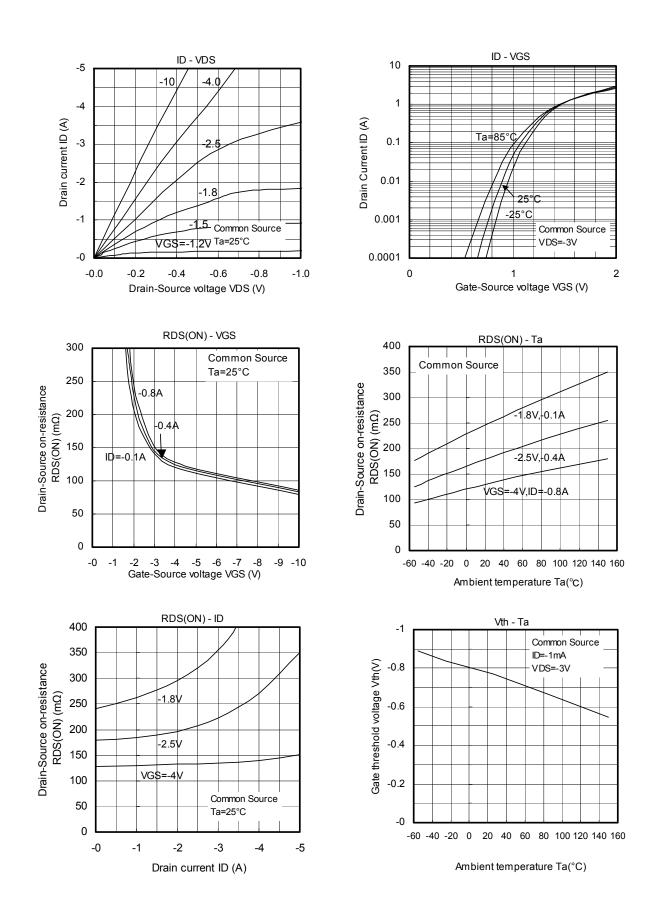
(The relationship can be established as follows: V\_{GS (off)} < V\_{th} < V\_{GS (on)})

Take this into consideration when using the device.

### **Handling Precaution**

When handling individual devices which are not yet mounted on a circuit board, be sure that the environment is protected against electrostatic discharge. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

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°C

0.8

Common Source VDD=10V VGS=0 to 2.5V Ta=25°C

1

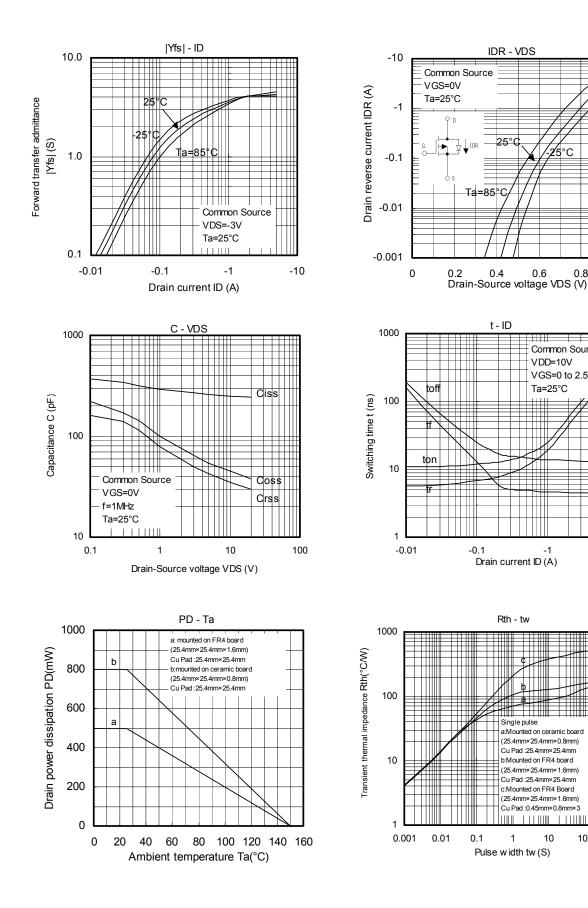
-10

0.6

-1

100

10



1000

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